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Part Number: [0736443200](#)
Status: **Active**
Overview: [hdm](#)
Description: 2.00mm (.079") Pitch HDM® Board-to-Board Backplane Header, Vertical, SMC, Press-Fit, Guide Post Location B, Polarizing Key Position A, 144 Circuits

Documents:
[3D Model](#)
[Drawing \(PDF\)](#)
[Test Summary \(PDF\)](#)
[RoHS Certificate of Compliance \(PDF\)](#)

Agency Certification

CSA LR19980
UL E29179

General

Product Family Backplane Connectors
Series [73644](#)
Application Backplane
Comments Standard Press-Fit, Tin/Lead (SnPb)
Component Type PCB Header
Overview [hdm](#)
Product Name HDM®
Style N/A

Physical

Circuits (Loaded) 144
Circuits (maximum) 144
Color - Resin Black, Natural
Durability (mating cycles max) 250
First Mate / Last Break No
Flammability 94V-0
Guide to Mating Part Yes
Keying to Mating Part Yes
Material - Metal Phosphor Bronze, Stainless Steel
Material - Plating Mating Gold
Material - Plating Termination Tin
Material - Resin High Temperature Thermoplastic
Number of Columns 24
Number of Pairs Open Pin Field
Number of Rows 6
Orientation Vertical
PC Tail Length (in) 0.138 In
PC Tail Length (mm) 3.50 mm
PCB Locator No
PCB Retention Yes
PCB Thickness Recommended (in) 0.098 In
PCB Thickness Recommended (mm) 2.50 mm
Packaging Type Tube
Pitch - Mating Interface (in) 0.079 In
Pitch - Mating Interface (mm) 2.00 mm
Pitch - Term. Interface (in) 0.079 In
Pitch - Term. Interface (mm) 2.00 mm
Plating min: Mating (µin) 30
Plating min: Mating (µm) 0.75
Plating min: Termination (µin) 15
Plating min: Termination (µm) 0.375



Series

image - Reference only

EU RoHS
Not RoHS Compliant
REACH SVHC
Not Reviewed
Halogen-Free
Status
Not Reviewed

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series
[73644Series](#)

Mates With
73632 HDM PLUS® Board-to-Board Daughtercard Receptacle. 73780 HDM® Board-to-Board Daughtercard Receptacle

Application Tooling FAQ	
Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.	
Global	
Description	Product #
Flat Rock Tooling for	0622013700
Pneumatic Press	
HDM® Backplane	0621001400
Insertion Signal	
Contact Tool	
HDM® Backplane	0622005703
Insertion Head for	
144 Positions	
Extraction Tool	0621001000

Polarized to PCB	No
Stackable	No
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-55°C to +105°C
Termination Interface: Style	Through Hole - Compliant Pin

Electrical

Current - Maximum per Contact	1A
Data Rate	1.0 Gbps
Real Signals (per 25mm)	75
Shielded	No
Voltage - Maximum	250V AC

Material Info

Reference - Drawing Numbers

Packaging Specification	PK-70873-0818
Sales Drawing	SDA-73644-****

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73644	4	3	2	73644
1. MATERIALS: HOUSING - LIQUID CRYSTAL POLYMER (LCP), GLASS-FILLED, UL94V-0, COLOR: BLACK, TERMINAL - PHOSPHOR BRONZE. 2. FINISHES: SELECTIVE GOLD (Au) IN CONTACT AREA, 0.00076mm MINIMUM THICKNESS; NICKEL (Ni) AND GOLD FLASH OVERALL SELECTIVE GOLD (Au) IN CONTACT AREA, 0.00076mm MIN. THICKNESS; SELECTIVE TIN/LEAD (Sb/Pb) IN TAIL AREA; NICKEL (Ni) OVERALL.				

10 9 8 7 6

NOTES:

F

E

D

C

B

The drawing illustrates the 73644 connector assembly. The isometric view shows the connector with its pins and housing. The side view shows the overall dimensions: a length of (B), a pin pitch of 2.00, a housing thickness of 0.92, a total height of (10.00), a pin height of 5X2.00, and a pin diameter of $\varnothing 0.20$. The cross-sectional view shows the internal structure with dimensions: a pin diameter of $\varnothing 0.20$, a pin height of 0.42, a housing thickness of 0.39, a pin pitch of 0.43, a total width of (15.7), a pin height of 7.05 $\pm$ 0.20, a housing height of 6.50, and a total height of 14.35 $\pm$ 0.15. The cross-section also shows the internal features: a pin diameter of $\varnothing 0.15$, a pin height of 7.05 $\pm$ 0.20, a housing thickness of 0.39, a pin pitch of 0.43, a total width of (15.7), a pin height of 6.50, and a total height of 14.35 $\pm$ 0.15. The cross-section also shows the internal features: a pin diameter of $\varnothing 0.15$, a pin height of 7.05 $\pm$ 0.20, a housing thickness of 0.39, a pin pitch of 0.43, a total width of (15.7), a pin height of 6.50, and a total height of 14.35 $\pm$ 0.15.

$\varnothing 0.20$ X Y Z

0.42
0.39

2.00

M $\pm$ 0.25

X

(0.43)

(15.7)

$\varnothing 0.15$ X Y Z

7.05 $\pm$ 0.20

6.50

14.35 $\pm$ 0.15

5X2.00

(10.00)

2.00

0.92

Y

(B)

A $\pm$ 0.10

$\varnothing 0.30$ X Y Z

73644-****
WW/YY

(0.40)

SEE NOTE 8

A					I	REVISED ECR UDT2000-0348 BINGHAM 99/10/12	DIMENSIONS SHOWN (IMPERIAL) INCH		▽ = 0 ▼ = 0		REVISE ONLY ON CAD SYSTEM																	
					H	REVISED ECR UDT1999-0662 BINGHAM 99/05/18	UNLESS OTHERWISE SPECIFIED TOLERANCES: ANGULAR ± 1/2°		TITLE SALES ASSY, HDM BACKPLANE MODULE, POLAR/GUIDE OPTION																			
					J	REVISED ECR UCP2003-2260 THOMAS 03/04/25	<table border="1"> <thead> <tr> <th></th> <th>INCH</th> <th>METRIC</th> </tr> </thead> <tbody> <tr> <td>3 PLACE</td> <td>± N/A</td> <td>---</td> </tr> <tr> <td>2 PLACE</td> <td>± N/A</td> <td>± 0.05</td> </tr> <tr> <td>1 PLACE</td> <td>---</td> <td>± 0.10</td> </tr> </tbody> </table>			INCH	METRIC	3 PLACE	± N/A	---	2 PLACE	± N/A	± 0.05	1 PLACE	---	± 0.10	MOLEX INCORPORATED LITTLE, ILL. 60532 U.S.A.				SHEET NO. 1 OF 2		DATE 96/12/18	
		INCH	METRIC																									
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2 PLACE	± N/A	± 0.05																										
1 PLACE	---	± 0.10																										
				G	REVISED ECR UDT1999-0476 BINGHAM 98/12/21	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		PART NO. SEE CHART		DRWG. NO. SDA-73644-*****																		
LTR.					REVISIONS	LTR.		REVISIONS		FILE NAME S73644X1 DGN		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INC. AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION.		DIV. DA		SIZE B												

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		I	REVISED ECR UDT2000-0348 BINGHAM 99/10/12
		H	REVISED ECR UDT1999-0662 BINGHAM 99/05/18
J	REVISED ECR UCP2003-2260 THOMAS 03/04/25	G	REVISED ECR UDT1999-0476 BINGHAM 98/12/21
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